INTEGRATED CIRCUITS

DATA SHEET

74F175*, **74F175A**Quad D flip-flop

* Discontinued part. Please see the Discontinued Product List in Section 1, page 21.

Product specification

1996 Mar 12

IC15 Data Handbook





Philips Semiconductors Product specification

Quad D flip-flop

74F175A

FEATURES

- Four edge-triggered D-type flip-flops
- Buffered common clock
- Buffered asynchronous Master Reset
- True and complementary outputs
- Industrial temperature range available (-40°C to +85°C)
- PNP light loading inputs

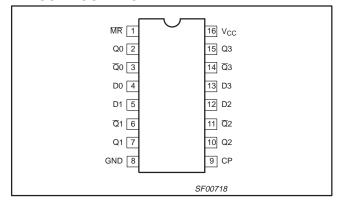
DESCRIPTION

The 74F175A is a quad, edge-triggered D-type flip-flop with individual D inputs and both Q and \overline{Q} outputs. The common buffered Clock (CP) and Master Reset (\overline{MR}) inputs load and reset (clear) all flip-flops simultaneously.

The register is fully edge-triggered. The state of each D input, one setup time before the Low-to-High clock transition is transferred to the corresponding flip-flop's Q output.

All Q outputs will be forced Low independently of clock or data inputs by a Low voltage level on the $\overline{\text{MR}}$ input. The device is useful for applications where both true and complementary outputs are required, and the CP and $\overline{\text{MR}}$ are common to all storage elements.

PIN CONFIGURATION



TYPE	TYPICAL f _{max}	TYPICAL SUPPLY CURRENT (TOTAL)
74F175A	160MHz	22mA

ORDERING INFORMATION

	ORDER CODE		
DESCRIPTION		PKG. DWG. #	
16-pin plastic DIP	74F175AN	SOT38-4	
16-pin plastic SO	74F175AD	SOT109-1	

INPUT AND OUTPUT LOADING AND FAN OUT TABLE

PINS	DESCRIPTION	74F (U.L.) HIGH/LOW	LOAD VALUE HIGH/LOW	
D0 – D3	Data inputs	74F175A	1.0/0.033	20μΑ/20μΑ
MR	Master reset input (active–Low)	74F175A	1.0/0.033	20μΑ/20μΑ
CP	Clock input (active rising edge)	74F175A	1.0/0.033	20μΑ/20μΑ
Q0-Q3	True outputs		50/33	1.0mA/20mA
<u>Q</u> 0− <u>Q</u> 3	Complementary outputs		50/33	1.0mA/20mA

NOTE:

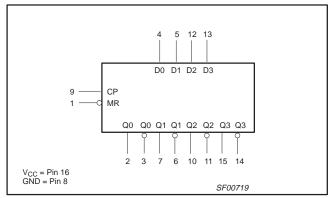
One (1.0) FAST unit load is defined as: 20µA in the High state and 0.6mA in the Low state.

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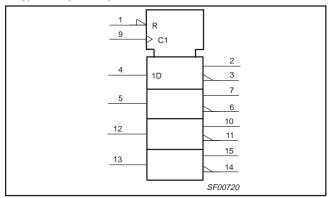
Quad D flip-flop

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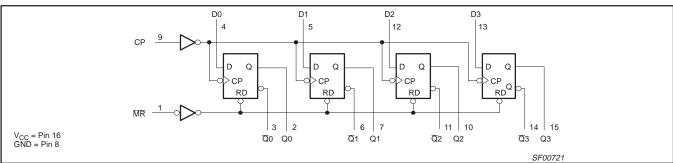
LOGIC SYMBOL



IEC/IEEE SYMBOL



LOGIC DIAGRAM



FUNCTION TABLE

	INPUTS		OUTF	PUTS	OPERATING
MR	СР	Dn	Q _n	Qn	MODE
L	Х	Х	L	Н	Reset (clear)
Н	\uparrow	h	Н	L	Load "1"
Н	1	I	L	Н	Load "0"

H = High voltage level h = High state must be present one setup time before the

Low-to-High clock transition

Low voltage level

Low state must be present one setup time before the

Low-to-High clock transition

Don't care

Low-to-High clock transition

ABSOLUTE MAXIMUM RATINGS

(Operation beyond the limit set forth in this table may impair the useful life of the device. Unless otherwise noted these limits are over the operating free air temperature range.)

SYMBOL	PARAMETER		RATING	UNIT
V _{CC}	Supply voltage		-0.5 to +7.0	V
V _{IN}	Input voltage		-0.5 to +7.0	V
I _{IN}	Input current		-30 to +5	mA
V _{OUT}	Voltage applied to output in High output state	–0.5 to V _{CC}	V	
I _{OUT}	Current applied to output in Low output state		40	mA
_	Operating free six temperature range	Commercial range	0 to +70	°C
T _{amb}	Operating free air temperature range	Industrial range	-40 to +85	°C
T _{stg}	Storage temperature range	-65 to +150	°C	

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RECOMMENDED OPERATING CONDITIONS

SYMBOL	PARAMETER			LIMITS		UNIT
			MIN	NOM	MAX	1
V _{CC}	Supply voltage		4.5	5.0	5.5	V
V _{IH}	High-level input voltage	2.0			V	
V _{IL}	Low-level input voltage			0.8	V	
I _{IK}	Input clamp current				-18	mA
I _{OH}	High-level output current				-1	mA
I _{OL}	Low-level output current			20	mA	
т		Commercial range	0		+70	°C
T _{amb}	Operating free air temperature range	Industrial range	-40		+85	°C

DC ELECTRICAL CHARACTERISTICS

(Over recommended operating free-air temperature range unless otherwise noted.)

SYMBOL	PARAMETER	TEST	TEST				UNIT
		CONDITIO	NS ¹	MIN	TYP ²	MAX	1
V _{OH}	High-level output voltage	V _{CC} = MIN, V _{IL} = MAX, V _{IH} = MIN, I _{OH} = MAX	±10%V _{CC}	2.5			V
VOH	Tigh-level output voltage	$V_{IH} = MIN, I_{OH} = MAX$	±5%V _{CC}	2.7	3.4		ľ
V _{OL}	Low-level output voltage	$V_{CC} = MIN, V_{IL} = MAX,$ $V_{IH} = MIN, I_{OL} = MAX$	±10%V _{CC}		0.30	0.5	V
		$V_{IH} = MIN, I_{OL} = MAX$	±5%V _{CC}		0.30	0.5	ľ
V_{IK}	Input clamp voltage	$V_{CC} = MIN, I_I = I_{IK}$			-0.73	-1.2	V
I _I	Input current at maximum input voltage	$V_{CC} = 0.0V, V_I = 7.0V$				100	μΑ
l _{IH}	High-level input current	$V_{CC} = MAX, V_I = 2.7V$				20	μΑ
I _{IL}	Low-level input current	V _{CC} = MAX, V _I = 0.5V 74F175A				-20	μΑ
I _{OS}	Short-circuit output current ³	V _{CC} = MAX	-60		-150	mA	
I _{CC}	Supply current (total)	V _{CC} = MAX	74F175A		22	31	mA

Notes to DC electrical characteristics

- 1. For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions for the applicable type.
- All typical values are at V_{CC} = 5V, T_{amb} = 25°C.
 Not more than one output should be shorted at a time. For testing I_{OS}, the use of high-speed test apparatus and/or sample-and-hold techniques are preferable in order to minimize internal heating and more accurately reflect operational values. Otherwise, prolonged shorting of a high output may raise the chip temperature well above normal and thereby cause invalid readings in other parameter tests. In any sequence of parameter tests, I_{OS} tests should be performed last.

AC ELECTRICAL CHARACTERISTICS FOR 74F175A

				0.50	20		IITS	T 40	901- 9590	
SYMBOL	PARAMETER	TEST CONDITION	$T_{amb} = 25^{\circ}C$ $V_{CC} = +5V$ $C_{L} = 50pF$, $R_{L} = 500\Omega$			$T_{amb} = 0^{\circ}C \text{ to } +70^{\circ}C$ $V_{CC} = +5.0V \pm 10\%$ $C_{L} = 50pF,$ $R_{L} = 500\Omega$		$T_{amb} = -40^{\circ}\text{C to } +85^{\circ}\text{C}$ $V_{CC} = +5.0\text{V} \pm 10\%$ $C_{L} = 50\text{pF},$ $R_{L} = 500\Omega$		UNIT
			MIN	TYP	MAX	MIN	MAX	MIN	MAX	
f _{max}	Maximum clock frequency	Waveform 1	140	160		125		110		MHz
t _{PLH} t _{PHL}	Propagation delay CP to Qn or Qn	Waveform 1	3.0 4.5	4.0 6.0	6.5 8.5	2.5 4.0	7.5 9.0	2.5 4.0	8.0 10.0	ns
t _{PLH} t _{PHL}	<u>MD</u> (- O -		4.5	6.5	9.0	4.5	10.0	4.5	11.0	ns
t _{PHL}	Propagation delay MR to Qn	Waveform 3	4.5	6.0	8.0	4.0	9.0	4.0	10.0	ns

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Quad D flip-flop

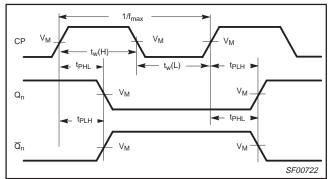
74F175A

AC SETUP REQUIREMENTS FOR 74F175A

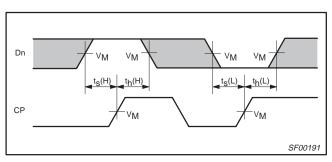
						LIN	IITS			
			Ta	_{imb} = 25°	С	$T_{amb} = 0^{\circ}C \text{ to } +70^{\circ}C$		$T_{amb} = -40^{\circ}C \text{ to } +85^{\circ}C$]
SYMBOL	PARAMETER	TEST		_{CC} = +5\			OV \pm 10%	$V_{CC} = +5.$		UNIT
		CONDITION	C _I	$C_L = 50pF,$ $R_L = 500\Omega$		C _L = 5 R _L =		$C_L = 50 pF,$ $R_L = 500 \Omega$		
			MIN	TYP	MAX	MIN	MAX	MIN	MAX	
$t_s(H)$ $t_s(L)$	Setup time, High or Low Dn to CP	Waveform 2	3.0 3.0			3.5 3.5		4.0 4.0		ns
t _h (H) t _h (L)	Hold time, High or Low Dn to CP	Waveform 2	0.0 0.0			0.0 0.0		0.0 0.0		ns
t _w (H) t _w (L)	CP Pulse width High or Low	Waveform 1	3.0 4.0			3.5 5.0		4.0 5.5		ns
t _w (L)	MR Pulse width Low	Waveform 3	3.5			3.5		4.0		ns
t _{REC}	Recovery time MR to CP	Waveform 3	4.0			4.5		5.0		ns

AC WAVEFORMS

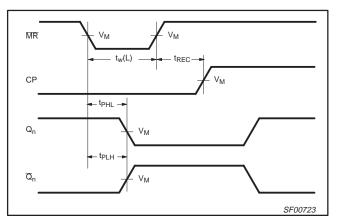
For all waveforms, $V_M = 1.3V$.



Waveform 1. Propagation delay for clock input to output, clock pulse width, and maximum clock frequency



Waveform 2. Data setup time and hold times



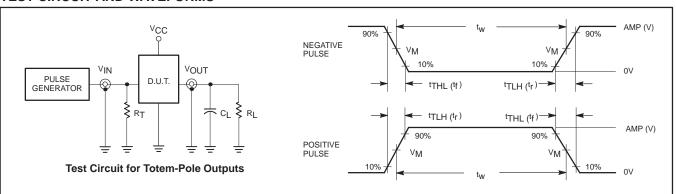
Waveform 3. Master Reset pulse width, Master Reset to output delay and Master Reset to Clock recovery time

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TEST CIRCUIT AND WAVEFORMS



DEFINITIONS:

R_L = Load resistor; see AC ELECTRICAL CHARACTERISTICS for value.

C_L = Load capacitance includes jig and probe capacitance; see AC ELECTRICAL CHARACTERISTICS for value.

R_T = Termination resistance should be equal to Z_{OUT} of

pulse generators.

Input Pulse Definition

family	INP	INPUT PULSE REQUIREMENTS									
	amplitude		V _M rep. rate		t _{TLH}	t _{THL}					
74F	74F 3.0V		1MHz	500ns	2.5ns	2.5ns					

SF00006

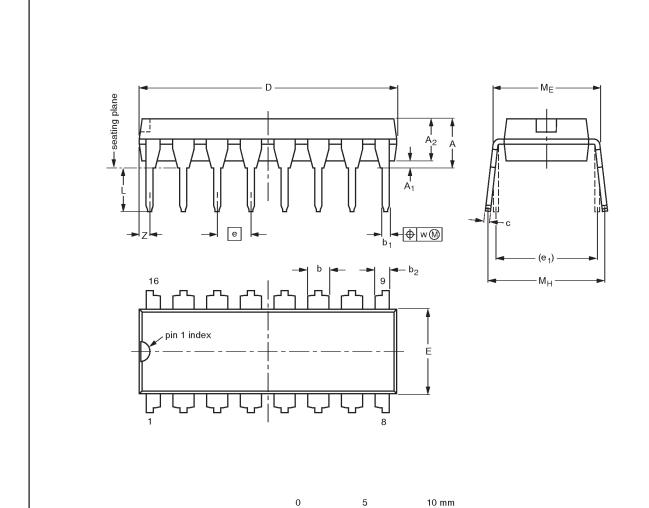
1996 Mar 12 6

Quad D flip-flop

74F175*, 74F175A

DIP16: plastic dual in-line package; 16 leads (300 mil)

SOT38-4



DIMENSIONS (inch dimensions are derived from the original mm dimensions)

UNIT	A max.	A ₁ min.	A ₂ max.	b	b ₁	b ₂	С	D ⁽¹⁾	E ⁽¹⁾	е	e ₁	L	ME	M _H	w	Z ⁽¹⁾ max.
mm	4.2	0.51	3.2	1.73 1.30	0.53 0.38	1.25 0.85	0.36 0.23	19.50 18.55	6.48 6.20	2.54	7.62	3.60 3.05	8.25 7.80	10.0 8.3	0.254	0.76
inches	0.17	0.020	0.13	0.068 0.051	0.021 0.015	0.049 0.033	0.014 0.009	0.77 0.73	0.26 0.24	0.10	0.30	0.14 0.12	0.32 0.31	0.39 0.33	0.01	0.030

scale

Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

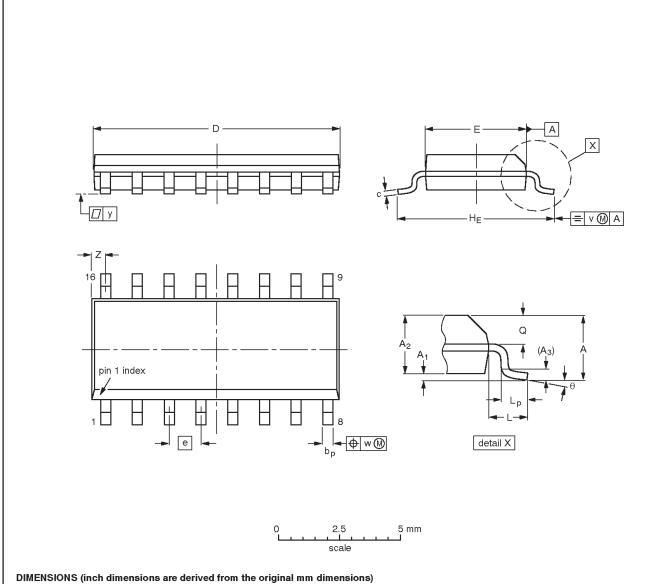
OUTLINE		REFER	EUROPEAN	ISSUE DATE	
VERSION	IEC	JEDEC	EIAJ	PROJECTION	ISSUE DATE
SOT38-4					92-11-17 95-01-14

^{*} Discontinued part. Please see the Discontinued Product List.

Quad D flip-flop

SO16: plastic small outline package; 16 leads; body width 3.9 mm

SOT109-1



UNIT	A max.	A ₁	A ₂	A ₃	bp	С	D ⁽¹⁾	E ⁽¹⁾	е	HE	L	Lp	Q	v	w	у	Z ⁽¹⁾	θ
mm	1.75	0.25 0.10	1.45 1.25	0.25	0.49 0.36	0.25 0.19	10.0 9.8	4.0 3.8	1.27	6.2 5.8	1.05	1.0 0.4	0.7 0.6	0.25	0.25	0.1	0.7 0.3	8°
inches	0.069	0.010 0.004	0.057 0.049	0.01		0.0100 0.0075		0.16 0.15	0.050	0.244 0.228	0.041		0.028 0.020	0.01	0.01	0.004	0.028 0.012	0°

Note

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.

OUTLINE		REFER	EUROPEAN	ISSUE DATE		
VERSION	IEC	JEDEC	EIAJ		PROJECTION	1330E DATE
SOT109-1	076E07S	MS-012AC				-95-01-23- 97-05-22

^{*} Discontinued part. Please see the Discontinued Product List.

Quad D flip-flop

74F175*, 74F175A

NOTES

^{*} Discontinued part. Please see the Discontinued Product List.

Philips Semiconductors Product specification

Quad D flip-flop

74F175*, 74F175A

Data sheet status

Data sheet status	Product status	Definition [1]
Objective specification	Development	This data sheet contains the design target or goal specifications for product development. Specification may change in any manner without notice.
Preliminary specification	Qualification	This data sheet contains preliminary data, and supplementary data will be published at a later date. Philips Semiconductors reserves the right to make chages at any time without notice in order to improve design and supply the best possible product.
Product specification	Production	This data sheet contains final specifications. Philips Semiconductors reserves the right to make changes at any time without notice in order to improve design and supply the best possible product.

^[1] Please consult the most recently issued datasheet before initiating or completing a design.

Definitions

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Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

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